MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model: MI0560FT

For Customer's Acceptance:

Customer		
Approved		
Comment		

Revision	1.0
Engineering	
Date	2010-04-06
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
01	2010-02-08	Initial release	
1.0	2010-04-06+	The first version final specification Add the value of the backlight power consumption Add the value of the panel power consumption Add the value of weight Add the value of current consumption Update the value of LCM module & total weight	



CONTENTS

- GENERAL INFORMATION
- EXTERNAL DIMENSIONS
- ABSOLUTE MAXIMUM RATINGS
- ELECTRICAL CHARACTERISTICS
- ELECTRO-OPTICAL CHARACTERISTICS
- INTERFACE DESCRIPTION
- APPLICATION NOTES
- TOUCH SCREEN PANEL SPECIFICATIONS
- RELIABILITY TEST
- INSPECTION CRITERION
- PRECAUTIONS FOR USING LCD MODULES
- PRIOR CONSULT MATTER



MODULE NO.: MI0560FT

■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	5.6	Inch
Viewing direction	12:00	O' Clock
Gray scale inversion direction	6:00	O' Clock
$LCM(W \times H \times D)$	126.5×101.0×7.1	mm ³
Active area (W×H)	112.896×84.672	mm ²
Dot pitch (W×H)	0.0588×0.1764	mm ²
Number of dots	640 (RGB) × 480	/
Backlight type	LED	/
Interface type	RGB	/
Color depth	262K	/
Surface treatment	Anti-glare	/
Color arrangement	RGB-stripe	/
Backlight power consumption	1.9	W
Panel power consumption	0.66	W
Input voltage	3.3	V
With/Without TSP	With TSP	/
Weight	TBD	g

Note 1:Refer to External Dimensions.

Note 2:Including LED Driver power consumption.

Note 3:Including T-con Board power consumption.

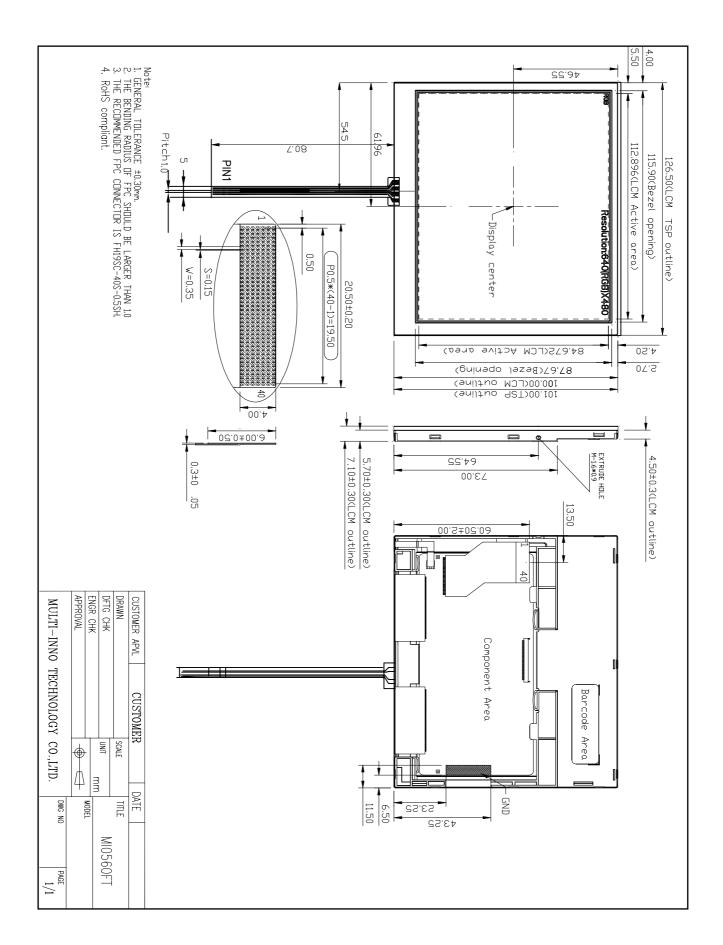
Note 4: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 5: RoHS compliant;

Note 6: LCM weight tolerance: ± 5%



■ EXTERNAL DIMENSIONS





MODULE NO.: MI0560FT

■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Dorryan volta ca	VCC	-0.3	6.5	V
Power voltage	$ m V_{LED}$	-0.3	6.5	V
Operating temperature	Тор	-10	60	°C
Storage temperature	Tst	-20	70	°C
Humidity	RH	-	90%(Max60°C)	RH

Note: The absolute maximum rating values of the module should not be exceeded. Once exceeded absolute maximum rating values, the characteristics of the module may not be recovered. Even in an extreme condition, may result in module permanently destroyed.

■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Downer weltage	VCC	3.1	3.3	3.5	V
Power voltage	$V_{ m LED}$	4.8	5.0	5.2	V
Current consumption	I cc	-	200	250	mA
Current consumption	I LED	-	380	450	mA
Input voltage 'H' level	VIH	0.7VCC	-	1VCC	V
Input voltage 'L' level	VIL	0	-	0.3VCC	V
LED life time	-	20,000	-	_	Hr

Note 1:Vcc setting should match the signals output voltage (refer to note 4) of customer's system board.

Note 2:LED driving voltage.

Note 3:LED driving current.

Note 4:DCLK,DE,HS,VS,R0-R5,G0-G5,B0-B5.

Note 5:The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and Vled=5.0V. The LED lifetime could be decreased if operating Vled is larger than 5.0V.

MODULE NO.: MI0560FT

■ELECTRO-OPTICAL CHARACTERISTICS

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response	time	Tr+Tf		-	25	50	ms	FIG 1.	4
Contrast r	atio	Cr	θ=0°	400	500	-		FIG 2.	1
	Luminance uniformity		Ø=0° Ta=25°C	70	75	-	%	FIG 2.	3
Surface Lum	inance	Lv		240	300	-	cd/m ²	FIG 2.	2
			Ø = 90°	40	50	-	deg	FIG 3.	
Viouving and	o rongo	θ	Ø = 270°	60	70	-	deg	FIG 3.	6
viewing angi	Viewing angle range			60	70	-	deg	FIG 3.	0
			Ø = 180°	60	70	-	deg	FIG 3.	
	Red	X		-	-	-			
	Reu	y		ı	1	-			
	Green	X	θ=0°	-	-	-			
CIE (x, y)	Green	у	Ø=0°	-	-	-		FIG 2.	5
chromaticity	Blue	X	Ta=25℃	-	-	-		110 2.	3
	Diuc	у	1 a-25 C	-	-	-			
	White	X		0.26	0.31	0.36			
	vv IIILE	у		0.28	0.33	0.38			

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

Contrast Ratio = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Note 3. The uniformity in surface luminance $, \delta$ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

δ WHITE = Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

- Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.
- Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.
- Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.



FIG. 1 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

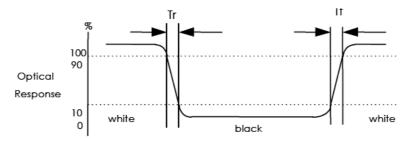
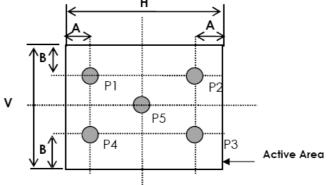


FIG. 2 Measuring method for Contrast ratio, surface luminance, Luminance uniformity , CIE (x, y) chromaticity

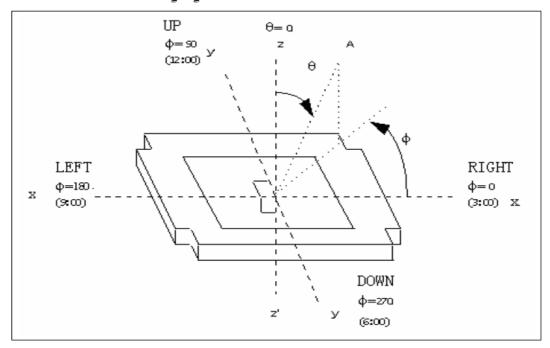


A: 5 mm B: 5 mm

H,V: Active Area

Light spot size ∅=7mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-5

FIG. 3 The definition of viewing angle





MODULE NO.: MI0560FT

■ INTERFACE DESCRIPTION

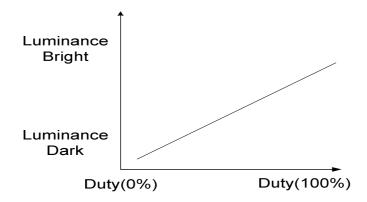
1. TFT LCD PanelD riving Section

FPC connector is used for the module electronics interface. The recommended model is

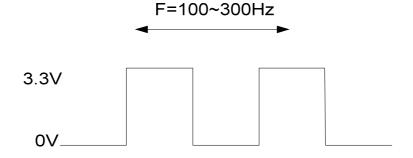
Pin No.	Symbol	I/O	Function	Remark
1	V_{LED}	Р	Power Voltage for LED circuit	
2	V_{LED}	Р	Power Voltage for LED circuit	
3	ADJ	I	Adjust the LED brightness with PWM Pulse	Note1,2
4	G _{LED}	Р	Ground for LED circuit	
5	G _{LED}	Р	Ground for LED circuit	
6	V _{CC}	Р	Power Voltage for digital circuit	
7	V _{CC}	Р	Power Voltage for digital circuit	
8	MODE	I	DE or HV mode control	Note 3
9	DE	I	Data enable	
10	VS	I	Vsync signal input	
11	HS	I	Hsync signal input	
12	GND	Р	Power ground	
13	B5	I	Blue data input (MSB)	
14	B4	I	Blue data input	
15	В3	I	Blue data input	
16	GND	Р	Power ground	
17	B2	I	Blue data input	
18	B1	I	Blue data input	
19	В0	I	Blue data input(LSB)	
20	GND	Р	Power ground	
21	G5	I	Green data input(MSB)	
22	G4	I	Green data input	
23	G3	I	Green data input	
24	GND	Р	Power ground	
25	G2	I	Green data input	
		i.		

26	G1	I	Green data input	
27	G0	I	Green data input(LSB)	
28	GND	Р	Power ground	
29	R5	I	Red data input(MSB)	
30	R4	I	Red data input	
31	R3	I	Red data input	
32	GND	Р	Power ground	
33	R2	I	Red data input	
34	R1	I	Red data input	
35	R0	I	Red data input(LSB)	
36	GND	Р	Power ground	
37	DCLK	I	Sample clock	
38	GND	Р	Power ground	
39	L/R	I	Select left to right scanning direction	Note4,5
40	U/D	I	Select up or down scanning direction	Note4,5

Note: I: input, O: output t, P: Power Note1: Pin.3 is used to adjust brightness.



Note 2:ADJ signal=0~3.3V,operation frequency:100~300Hz







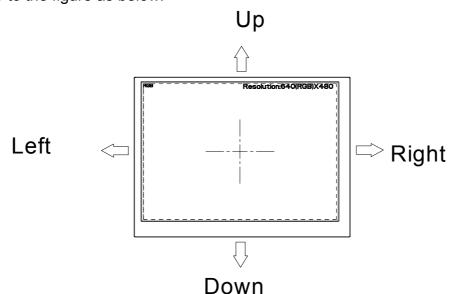
Note 3: DE Mode, Mode="H",HS floating and VS floating HV Mode, Mode="L" and DE floating

Note 4: Selection of scanning mode

Setting of scan control input U/D L/R		Scanning direction
GND	V _{CC}	Up to down, left to right
V _{CC}	GND	Down to up, right to left
GND	GND	Up to down, right to left
V _{CC}	V _{CC}	Down to up, left to right

Note 5: Definition of scanning direction.

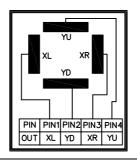
Refer to the figure as below:



2. Touch Screen Panel Section

Pin No.	Symbol	I/O	I/O Function	
1	XL	Left	Left electrode-differential analog	
2	YD	Bottom	Bottom electrode-differential analog	
3	XR	Right	Right electrode-differential analog	
4	YU	Тор	Top electrode-differential analog	

Note: Touch screen panel block





MODULE NO.: MI0560FT

■ APPLICATION NOTES

- 1 Timing characteristicsk
 - 1.1 Timing conditions

Input/Output Timing

Item	Symbol		Values		Unit.	Remark
item	Symbol	Min.	Тур.	Max.	Unit. Remark	
PXLCLK clock time	Tclk	33.3	39.7	-	ns	
PXLCLK pulse duty	Tcwh	40	50	60	%	Tclk
DATA set-up time	Tdsu	12	-	-	ns	DATA to PXLCLK
DATA hold time	Tdhd	12	-	-	ns	DATA to PXLCLK
DE setup time	Tesu	12	-	-	ns	DE to PXLCLK
VSYNC setup time	Tvst	12	-	-	ns	
VSYNC hold time	Tvhd	12	-	-	ns	
HSYNC setup time	Thst	12	-	-	ns	
HSYNC hold time	Thhd	12	-	-	ns	
HSYNC period time	Th	22.91	31.76	-	us	
HSYNC width	Thwh	1	-	-	Tclk	
VSYNC width	Tvwh	1	-	-	Th	
HSYNC to CLKIN	Thc	-	-	1	Tclk	

DE Mode input Timing Limitation

DE Mode		Values	Unit	Remark	
DE MOGE	Min.	Тур.	Max.	Offic	Remark
THC	48	160	765	tclk	
THD	640	640	640	tclk	
TH	688	800	1405	tclk	1TH=1line
TVC	6	45	255	line	
TVD	480	480	480	line	
TV	486	525	735	line	1TV=1field



HV Mode input Timing Limitation

HV Mode		Values	- Unit	D I	
nv Mode	Min.	Тур.	Max.	Oilit	Remark
Thwh	-	10	-	tclk	
Thbp	-	134	-	tclk	
Thfp	-	16	-	tclk	
THD	-	640	-	tclk	
TH	-	800	-	tclk	1TH=1 line
Tvwh	-	2	-	line	
Tvbp	-	11	-	line	
Tvfp	-	32	-	line	
TVD	-	480	-	line	
TV	-	525	-	line	1TV=1 field



1.2 Timing Diagram

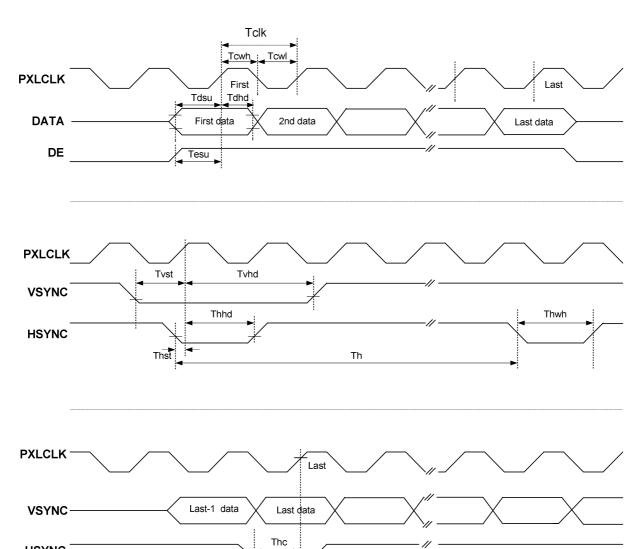


Fig.3-1 Clock and Data Input Timing Diagram

HSYNC



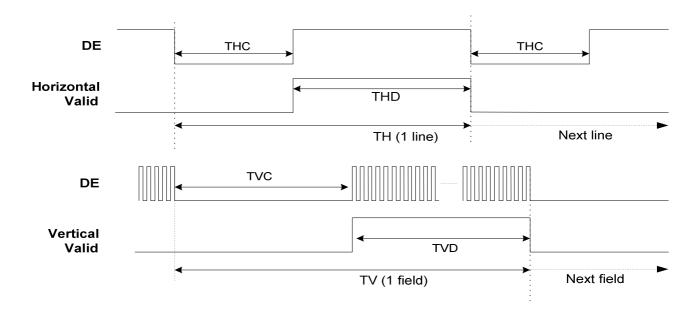


Fig.3-2 DE Mode Input Timing

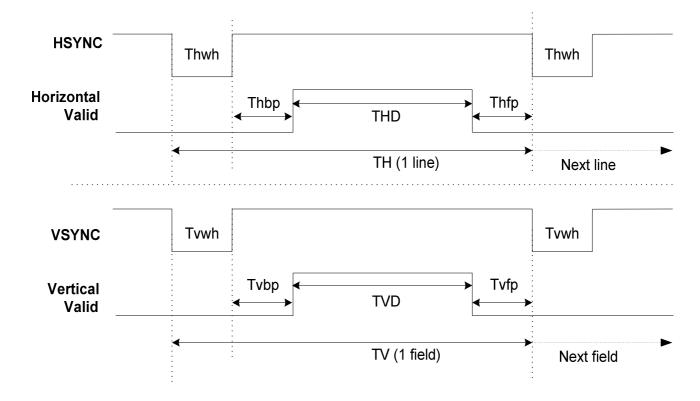


Fig.3-3 HV Mode Input Timing



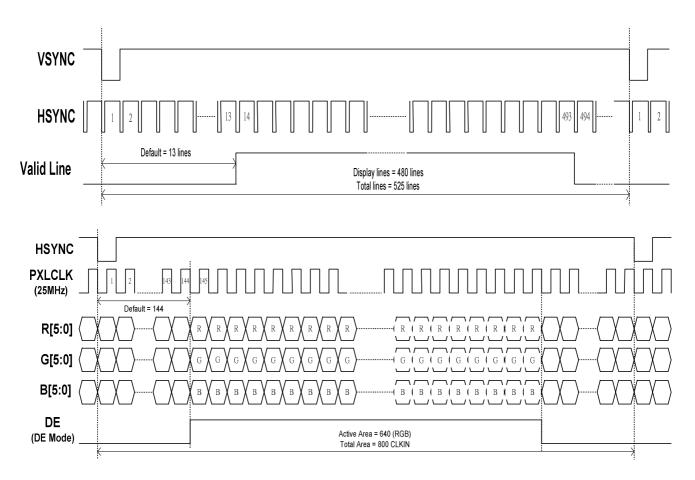
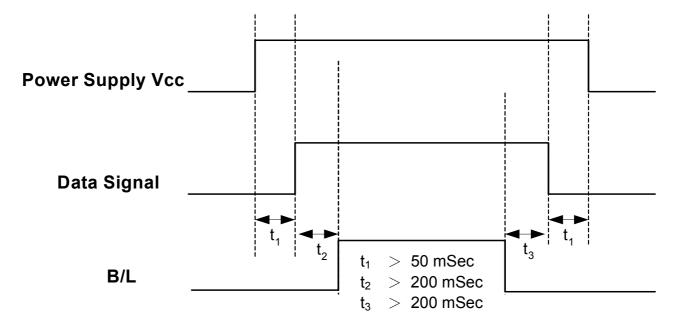


Fig. 3-4 18 bit RGB mode for 640 x (RGB) x 480

2 Power sequence



Note:Data includes DE, VS ,HS,B0~B5,G0~G5,R0~R5,DCLK.



MODULE NO.: MI0560FT Ver 1.0

■ TOUCH SCREEN PANEL SPECIFICATIONS

1. Electrical Characteristics

Item		Value		Unit	Remark	
ltem	Min.	Тур.	Max.	Oilit	Remark	
Linearity	-1.5	-	1.5	%	Analog X and Y directions	
Terminal	410	-	750	Ω	X(Film side)	
Resistance	220	-	410	Ω	Y(Glass side)	
Insulation resistance	20	-	-	ΜΩ	DC 25V	
Voltage	-	-	10	V	DC	
Chattering	-	-	10	ms	100kΩ pull-up	
Transparency	78	-	-	%		

Note: Avoid operating with hard or sharp material such as a ball point pen or a mechanical pencil except a polyacetal pen (tip R0.8mm or less) or a finger.

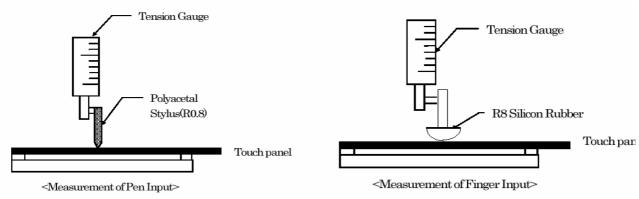
2. Mechanical & Reliability Characteristics

ltem		Value		Unit	Remark
	Min.	Тур.	Max.	Offic	Kemark
Active force	100	-	-	gf	Note 1
Durability-surface scratching	Write 100,000	-	-	characters	Note 2
Durability-surface pitting	1,000,000	-	-	touches	Note 3
Surface hardness	3	-	-	Н	

Note 1: Active force test condition

- (1) Input DC 5V on X direction, Drop off Polyacetal Stylus (R0.8), until output voltage stabilize ,then get the activation force •
- (2) R8.0mm Silicon rubber for finger Activation force test
- (3) Test point: 9 points





Note 2: Measurement for surface area.

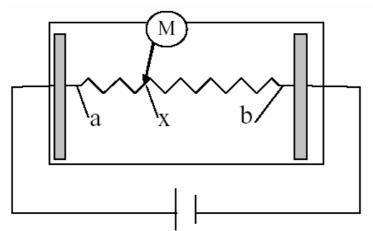
- -Scratch 100,000 times straight line on the film with a stylus change every 20,000 times.
- -Force: 250gf.
- -Speed: 60mm/sec.
- -Stylus: R0.8 polyacetal tip.

Note 3: Pit 1,000,000 times on the film with a R0.8 silicon rubber.

-Force: 250gf.

-Speed: 2times/sec.

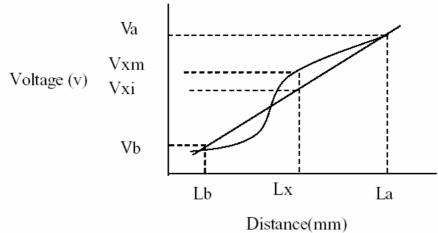
3. Linearity Definition



Va: maximum voltage in the active area of touch panel Vb: minimum voltage in the active area of touch panel

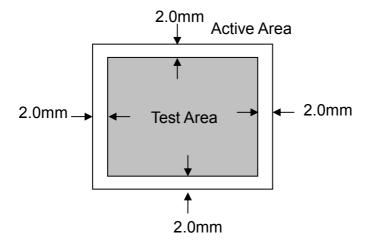
X: random measuring point Vxm: actual voltage of Lx point Vxi: theoretical voltage of Lx point





Linearity = [|Vxi-Vxm |/(Va-Vb)]*100%

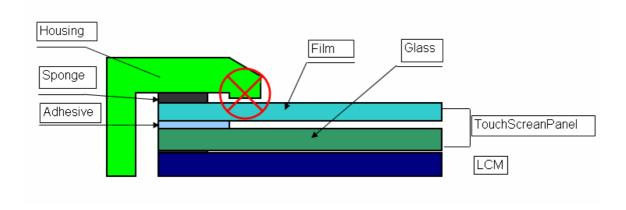
Note: Test area is as follows and operation force is 150gf.



4. Housing Design Guide

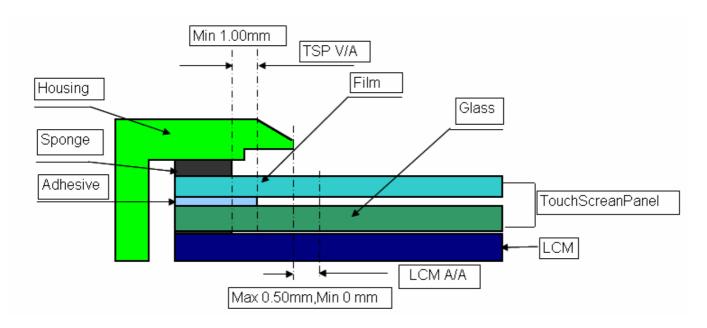
Housing design follow as below.

- 1) Avoid the design that housing overlap and press on the active area of the LCM.
- 2) Give enough gap(over 0.5mm at compressed) between the housing and TSP to protect wrong operating.





- 3) Use a buffer material(Gasket) between the TSP and housing to protect damage and wrong operating.
- 4) Avoid the design that buffer material overlap and press on the inside of TSP view area.





■ RELIABILITY TEST

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	70 ± 2 °C/240 hours	Note 1,Note 4
2	Low Temperature Storage	-20 ± 2 °C/240 hours	Note 1,Note 4
3	High Temperature Operating	60 ± 2 °C/240 hours	Note 2,Note 4
4	Low Temperature Operating	-10 ± 2 °C/240 hours	Note 1,Note 4
5	Temperature Cycle	$-20\pm2^{\circ}\text{C}\sim25\sim70\pm2^{\circ}\text{C}\times100\text{cycles}$	Note 4
6	Damp Proof Test	$40^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH/240 hours}$	Note 4
7	Vibration Test	Frequency range: 10Hz~55Hz Stroke: 1.5mm, Sweep: 10Hz~55Hz~10Hz 2hours for each direction of X,Y,Z. (6 hours for total)	
8	Mechanical Shock	100G 6ms, ±X,±Y,±Z 3times for each direction	
9	Package Drop Test	Height:60 cm 1 corner, 3 edges, 6 surfaces	
10	Package Vibration Test	Random Vibration: 0.015G*G/Hz from 5-200Hz,-6dB/Octave from 200-500Hz 2 hours for each direction of X.Y.Z. (6 hours for total)	
11	ESD test	±2KV,Human Body Mode, 100pF,/1500Ω	

- Note 1: Ta is the ambient temperature of samples.
- Note 2: Ts is the temperature of panel's surface.
- Note 3: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but doesn't guarantee all the cosmetic specification.
- Note 4: Before cosmetic and function tests, the product must have enough recovery time,at least 2 hours at room temperature.

MODULE NO.: MI0560FT

■ INSPECTION CRITERION

MI	OUTGOING QUALITY STANDARD	PAGE 1 OF 8
TITLE:FUNCTIO	ONAL TEST & INSPECTION CRITERIA	

This specification is made to be used as the standard acceptance/rejection criteria for Wider Screen TFT-LCD module product.

1. Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

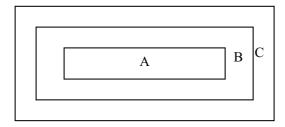
Major defect: AQL 0.65 Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40W$ light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of Inspection Item.

3.1 Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product) ZoneB+ZoneC= Around opaque edge area on TP.

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

3.2 Definition of some visual defect

Bright dot.	Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.
Dark dot.	Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture, or pure whiter picture.
Dark / Bright Lines.	Lines on display which appear dark/bright and usually result from the contamination.





PAGE 2 OF 8

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

4. Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1	All functional defects	 No display Display abnormally Open or missing segment Short circuit Excess power consumption Back-light no lighting, flickering and abnormal lighting. 	
4.2	Missing	Missing component	Major
4.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
4.4	Crack	Creaks tend to break are not allowed.	

5. Minor Defect

Item No	Items to be inspected		Inspection St	andard		Classification of defects
	Bright dot. defect.	Zone Size(mm)		acceptable		
		Size(min)	A	В	C	
5.1	5.1 y	Ф≤0.15	Acceptable of spot not		Acceptable	
	$\Phi = (x+y)/2$	0.15<Φ≤0.25	N≤6.			
		0.25<Φ≤0.50	N≤2			
						Minor
		Zone		Acceptable	e Q'ty	
		Size(mm)	A	В	С	
5.2	Dark dot defect.	Ф ≤0.15	Accep	table		
		0.15<Φ≤0.30) N<	≤6	Acceptable	
		0.30<Φ≤0.5	50 N	€4		
5.3	Bright / Dark line.	$0.01 < W \le 0.10, 0.30 < L \le 1.50,$ $N \le 1$			Acceptable	
Note:	1 Total dafaati	va data shall not ayaa	ad 6 mag			

Note: 1. Total defective dots shall not exceed 6 pcs.

- 2. Minimum distance between defective dots is more than 5mm.
- 3. 2 Adjacent dark sub pixel defect or bright sub pixel defect is not more than 1pair.
- 4. W: Width, L: Length, N: Count.





PAGE 3 OF 8

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

Item No	Items to be inspected		Inspection	Standar	d		Classification of defects
							Minor
	Linear defect	Size	e(m)	Acc	eptable Qty		
	Foreign material under polarizer,	L(Length)	W(Width)	A	Zone	С	
		Ignore	W≤0.05	Acc	eptable	Acc	
		L≤5.0	$0.05 < W \le 0.1$	15	N≤5	Acceptable	
~ .		5.0≤L	0.15≤W		0	ble	
5.4	Circular Defect,						Minor
	Foreign material under polarizer,	Zon	e	Acceptab	ole Q'ty		
	under polarizer,	Size(mm)	A	В	(
		$\Phi \leq 0.25$	Acce	Acceptable			
	$\Phi = (x+y)/2$	0.25<Φ≤0.50	0 N	N≤4		otable	
		0.50≤Φ		0			
		5.4.1 Polarizer P (i) Shifting in dimension. (ii) Incomplete is not allow 5.4.2 Dirt on pol Dirt which 6.5.4.3 Polarizer N	position should covering of the wed. arizer can be wiped e	viewing a	area due to sh	iifting	Minor
5.5	Polarizer	Sizes(mm)		Acceptal	ble Qty		
2. 2	defect.			Zoı	Zone		
			A	В	C		
		Ф < 0.25	Acce	ptable	e		
		0.25≪ Ф ≪ 0.5		€4	Acceptal	ole	
		Ф>0.5		0			
						-	





PAGE 4 OF 8

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

5. Minor Defect

Item No	Items to be inspected		Inspection S	Standard	l		Classification of defects
		5.4.4Air bubbl	es between glass	& pola	rizer:		Minor
				Acce	eptable	e Qty	
		Size(mm)		Zone		
			A	I	3	С	
		Φ <		ceptabl	e		
		0.3<	-	3		Acceptable	
		1.0<		1		1	
		Φ>	1.5	0			
		5.4.5 Polarizer	scratch				Minor
5.6	Polarizer defect	assembling or in the operating condition, judge by the line defect of 5.4. (ii) If the Polarizer scratch can be seen only in non-operating condition or some special angle, judge by the following. Size(mm) Acceptable Qty					in
		L(Length)	W(Width)	Zone		one	
		L(Lengui)	w (widdi)	A	В	C	
		Ignore	W≤0.02	Ign	ore		
		1.0 <l≤5.0< td=""><td>0.02<w≤0.2< td=""><td>N≤</td><td>≤4.</td><td>Ignore</td><td></td></w≤0.2<></td></l≤5.0<>	0.02 <w≤0.2< td=""><td>N≤</td><td>≤4.</td><td>Ignore</td><td></td></w≤0.2<>	N≤	≤ 4.	Ignore	
		5.0 <l< td=""><td>0.2<w< td=""><td>0</td><td>)</td><td></td><td></td></w<></td></l<>	0.2 <w< td=""><td>0</td><td>)</td><td></td><td></td></w<>	0)		





PAGE 5 OF 8

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

5. Minor Defect

No	Items to be inspected]	Inspection Standard		Classificatio n of defects
		(i) Crack Cracks are not allo	wed.		Minor
5.7	Glass defect	(ii) TFT chips on corne	er Z	Acceptable	Minor
		≤3.0 ≤3.0 Chips on the corner of into the ITO pad or exp	Not more than the thickness of glass. of terminal shall not be cose perimeter seal.	N≤3.	Į.
(iii)Usual surface cracks		<u> </u>	Minor		
		X Y	Z Not more than the	Acceptable	
		≤1.5 ≤1.5			





PAGE 6 OF 8

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

6. TI	P Cosm	ıetic	Defe	ct.
-------	---------------	-------	------	-----

Item No	Items to be inspected	Inspection Standard			Classification of defects			
	Black and	For dark/white sp as $\Phi = \frac{(x+y)}{2}$	ot, size⊕is define	d		Ç Y X Y		
				ne Acceptable Qty				
6.1	white Spot defect	Size(mm)	A	В+	+C		Minor	
0.1	Foreign	Φ≤0.15	Igno	ore			Minor	
	Particle,	0.15<Φ≤0.	25 6			distance 5mm		
		0.25< Ф ≤0.	50 4	-		over		
		Φ>0.5	0)				
		Total defective TP.	e dots shall not exc	eed 6	pcs on	the same		
Item No	Items to be inspected	Inspection Standard			Classification of defects			
	Black line, White line, Scratch, Foreign material under film,	G:	()			11.0		
		Size	(mm)	Acceptable Qty Zone				
			L(Length)	W(Width)	A	B+C	ne	
6.2		Ignore	W≤0.03		ore			
		L≤5.0	0.03 <w≤0.05< td=""><td></td><td>5</td><td>distance</td><td>Minor</td></w≤0.05<>		5	distance	Minor	
			L≤5.0	0.05 <w≤0.1< td=""><td>2</td><td>2</td><td>5mm over</td><td></td></w≤0.1<>	2	2	5mm over	
			0.1 <w< td=""><td></td><td>0</td><td></td><td></td></w<>		0			





PAGE 7 OF 8

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

6. TP Cosmetic Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
		(i) Chips on corner X Y	Minor
6.3	TP defect	(ii)Usual surface cracks $ X = X = X = X = X = X = X = X = X = X$	Minor
		(iii) Crack Cracks tending to break are not allowed.	Major
6.4	Total number of dots	The total number of luminous dots, dark dots, contamination particles, bubbles, scratch defects, pinholes must not exceed 10 /piece on the same TP.	





PAGE 8 OF 8

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

7	Modul	le Cosm	etic (Criteria
- /		IE ((1511)		ппена

Item No	Items to be inspected	Inspection Standard	Classification of defects
1	Difference in Spec.	None allowed	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3	Soldering defects	No soldering missing No soldering bridge No cold soldering	Major Major Minor
4	Resist flaw on Printed Circuit Boards	st flaw on Printed visible copper foil (Ø0.5mm or more) on substrate	
5	Accretion of metallic Foreign matter	No accretion of metallic foreign matters (Not exceed \emptyset 0.2mm).	Minor Minor
6	Stain	No stain to spoil cosmetic badly.	Minor
7	Plate discoloring	No plate fading, rusting and discoloring.	Minor
8	Solder amount 1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly. (too much) b. Components side (In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
	2. Flat packages	Either 'Toe' (A) or 'Seal' (B) of the lead to be covered by 'Filet'. Lead form to be assume over solder.	Minor
	3. Chips	$(3/2) H \ge h \ge (1/2) H$	Minor
9	Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad $h \ge 0.13$ mm. The diameter of solder ball d ≤ 0.15 mm. b. The quantity of solder balls or solder. Splashes isn't beyond 5	Minor Minor
		in 600 mm ² . c.Solder balls/Solder splashes do not violate minimum electrical clearance.	Major
		d.Solder balls/Solder splashes must be entrapped / encapsulated or attached to the metal surface .	Minor
		Note: Entrapped/encapsulated/attached is intended to mean that normal service environment of the product will not cause a solder ball to become dislodged.	



■ PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
 - (9) Do not attempt to disassemble or process the LCD module.
 - (10) NC terminal should be open. Do not connect anything.
 - (11) If the logic circuit power is off, do not apply the input signals.
- (12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated



- (13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist LCM.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- -Terminal electrode sections.



2 Handling precaution for LCM

2.1 LCM is easy to be damaged. Please note below and be careful for handling.

2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



Please don't touch IC directly.



Please don't hold the surface of panel.



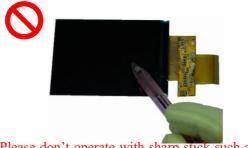
Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Transportation Precautions

- 3.2.1 During shipment, please handle with care. The packaging bag can not be broken, step on trap. Packaging Carton layer height can not be over two meters.
- 3.2.2 The transportation process should pay attention to the waterproof and moisture-proof measures. Product can not be watering. Ethylene sealed bags can not be unsealed.

3.3 Others

- 3.3.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.3.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.3.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.3.3.1 Exposed area of the printed circuit board.
 - 3.3.3.2 -Terminal electrode sections.

4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C. Time : 3-5S.	330°C ~350°C. Speed : 4-8 mm/s.	300°C ~330°C. Time : 3-6S. Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C. Time : 3-5S.	350°C ~370°C. Time : 4-8 mm/s.	330°C ~360°C. Time : 3-6S. Press: 0.8~1.2Mpa

4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.



- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.



4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
 - 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.